PATENT COOPERATION TREATY

From the INTERNATIONAL PRELIMINARY EXAMINING AUTHORITY

To:

HARRISON GODDARD FOOTE Belgrave Hall Belgrave Street Leeds LS2 8DD

PCT

NOTIFICATION OF TRANSMITTAL OF THE INTERNATIONAL PRELIMINARY REPORT ON PATENTABILITY

167285 18 JUL 0 5

(PCT Rule 71.1)

Date of mailing

(day/month/year)

06.07.2005

Applicant's or agent's file reference

LPB/P101655WO

IMPORTANT NOTIFICATION

International application No. PCT/GB2004/001366

GRANDE BRETAGNE

International filing date (day/month/year)

Priority date (day/month/year)

31.03.2004

01.04.2003

Applicant

DE-BONDING LIMITED

- 1. The applicant is hereby notified that this International Preliminary Examining Authority transmits herewith the international preliminary report on patentability and its annexes, if any, established on the international application.
- 2. A copy of the report and its annexes, if any, is being transmitted to the International Bureau for communication to all the elected Offices.
- 3. Where required by any of the elected Offices, the International Bureau will prepare an English translation of the report (but not of any annexes) and will transmit such translation to those Offices.

4. REMINDER

The applicant must enter the national phase before each elected Office by performing certain acts (filing translations and paying national fees) within 30 months from the priority date (or later in some Offices) (Article 39(1)) (see also the reminder sent by the International Bureau with Form PCT/IB/301).

Where a translation of the international application must be furnished to an elected Office, that translation must contain a translation of any annexes to the international preliminary report on patentability. It is the applicant's responsibility to prepare and furnish such translation directly to each elected Office concerned.

For further details on the applicable time limits and requirements of the elected Offices, see Volume II of the PCT Applicant's Guide.

The applicant's attention is drawn to Article 33(5), which provides that the criteria of novelty, inventive step and industrial applicability described in Article 33(2) to (4) merely serve the purposes of international preliminary examination and that "any Contracting State may apply additional or different criteria for the purposes of deciding whether, in that State, the claimed inventions is patentable or not" (see also Article 27(5)). Such additional criteria may relate, for example, to exemptions from patentability, requirements for enabling disclosure, clarity and support for the claims.

Name and mailing address of the international preliminary examining authority:

European Patent Office - P.B. 5818 Patentlaan 2 NL-2280 HV Rijswijk - Pays Bas Tel. +31 70 340 - 2040 Tx; 31 651 epo ni Fax: +31 70 340 - 3016

Authorized Officer

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PATENT COOPERATION TREATY

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INTERNATIONAL PRELIMINARY REPORT ON PATENTABILITY

(Chapter II of the Patent Cooperation Treaty)

(PCT Article 36 and Rule 70)

Applicant's or agent's file reference LPB/P101655WO	FOR FURTHER ACTIO	N See Form PCT/IPEA/416					
International application No. PCT/GB2004/001366	International filing date (day/mid 31.03.2004	onthlyear) Priority date (day/monthlyear) 01.04.2003					
International Patent Classification (IPC) or national classification and IPC C09J5/00, C09J5/08, B60J10/02, C08J9/32							
Applicant DE-BONDING LIMITED	,						
This report is the international pre- Authority under Article 35 and trans		established by this International Preliminary Examining ording to Article 36.					
2. This REPORT consists of a total of	f 6 sheets, including this cov	ver sheet.					
3. This report is also accompanied by	y ANNEXES, comprising:						
a. 🖾 sent to the applicant and to	the International Bureau) a t	total of 8 sheets, as follows:					
⊠ sheets of the description and brands sheets containing Administrative Instructi	ig rectifications authorized by	nich have been amended and are the basis of this report this Authority (see Rule 70.16 and Section 607 of the					
☐ sheets which supersed beyond the disclosure Supplemental Box.	e earlier sheets, but which th in the international application	nis Authority considers contain an amendment that goes n as filed, as indicated in item 4 of Box No. I and the					
sequence listing and/or tab	les related thereto, in comput	e type and number of electronic carrier(s)) , containing a ter readable form only, as indicated in the Supplemental se Administrative Instructions).					
4. This report contains indications rel	ating to the following items:						
☑ Box No. I Basis of the opin	ion						
☐ Box No. II Priority							
Box No. III Non-establishme	ent of opinion with regard to n	novelty, inventive step and industrial applicability					
Box No. IV Lack of unity of i	nvention						
applicability; cita	tions and explanations suppo	regard to novelty, inventive step or industrial orting such statement					
Box No. VI Certain documents cited							
	n the international application						
☐ Box No. VIII Certain observat	ions on the international appl	lication					
Date of submission of the demand	Date	of completion of this report					
04 00 0005							
01.03.2005	06.0	07.2005					
Name and mailing address of the international preliminary examining authority:		07.2005 Drized Officer					

10/551335 JC09 Rec'd PCT/PTO 29 SEP 2005

INTERNATIONAL PRELIMINARY REPORT ON PATENTABILITY

International application No. PCT/GB2004/001366

_	Box No. I	Basis of the report
1.	With regard filed, unless	to the language , this report is based on the international application in the language in which it was otherwise indicated under this item.
		port is based on translations from the original language into the following language, s the language of a translation furnished for the purposes of:
	☐ pub	rnational search (under Rules 12.3 and 23.1(b)) lication of the international application (under Rule 12.4) rnational preliminary examination (under Rules 55.2 and/or 55.3)
2.	have been t	to the elements* of the international application, this report is based on (replacement sheets which furnished to the receiving Office in response to an invitation under Article 14 are referred to in this originally filed" and are not annexed to this report):
	Description,	. Pages
	1-27	as published
	Claims, Num	nbers
	1-42	received on 03.03.2005 with letter of 01.03.2005
	Drawings, S	heets
	1/3-3/3	as published
	□ a seque	ence listing and/or any related table(s) - see Supplemental Box Relating to Sequence Listing
3.	☐ The am	endments have resulted in the cancellation of:
		description, pages claims, Nos.
	☐ the o	drawings, sheets/figs sequence listing <i>(specify)</i> :
		table(s) related to sequence listing (specify):
4.	had not bee	port has been established as if (some of) the amendments annexed to this report and listed below n made, since they have been considered to go beyond the disclosure as filed, as indicated in the al Box (Rule 70.2(c)).
		description, pages claims, Nos.
	☐ the c	drawings, sheets/figs
		sequence listing (specify): table(s) related to sequence listing (specify):
	* If ite	m 4 applies, some or all of these sheets may be marked "superseded."

INTERNATIONAL PRELIMINARY REPORT ON PATENTABILITY

International application No. PCT/GB2004/001366

		x No. III Non-establishment c olicability	of op	inion with regard to novelty, inventive step and industrial			
1.		ne questions whether the claimed invention appears to be novel, to involve an inventive step (to be non- ovious), or to be industrially applicable have not been examined in respect of:					
		the entire international application,					
	\boxtimes	claims Nos. 32-37					
		because:					
		the said international application, or the said claims Nos. relate to the following subject matter which does not require an international preliminary examination (specify):					
		the description, claims or drawings (indicate particular elements below) or said claims Nos. are so unclear that no meaningful opinion could be formed (specify):					
		the claims, or said claims Nos. are so inadequately supported by the description that no meaningful opinion could be formed.					
	\boxtimes	no international search report h	as b	een established for the said claims Nos. 32-37			
		the nucleotide and/or amino acid sequence listing does not comply with the standard provided for in Annex C of the Administrative Instructions in that:					
		the written form		has not been furnished			
				does not comply with the standard			
		the computer readable form		has not been furnished			
				does not comply with the standard			
		the tables related to the nucleotide and/or amino acid sequence listing, if in computer readable form only, do not comply with the technical requirements provided for in Annex C-bis of the Administrative Instructions.					
		See separate sheet for further of	detail	is			

INTERNATIONAL PRELIMINARY REPORT ON PATENTABILITY

International application No. PCT/GB2004/001366

	Bo	x No. IV	Lack of unity of i	nventio	n			
1.	 In response to the invitation to restrict or pay additional fees, the applicant has: □ restricted the claims. □ paid additional fees. □ paid additional fees under protest. ☑ neither restricted nor paid additional fees. 							
2.		This Authority found that the requirement of unity of invention is not complied with and chose, according to Rule 68.1, not to invite the applicant to restrict or pay additional fees.						
3.	This	his Authority considers that the requirement of unity of invention in accordance with Rules 13.1, 13.2 and 13.3						
		complied	with.					
	\boxtimes	not complied with for the following reasons:						
		see separate sheet						
4. Consequently, this report has been established in respect of the following parts of the international appli					spect of the following parts of the international application:			
		□ all parts.						
	\boxtimes	☑ the parts relating to claims Nos. 1-31,38-42.						
		No. V licability;				5(2) with regard to novelty, inventive step or industrial ing such statement		
1.	Stat	ement						
	Novelty (N)		Yes: No:	Claims Claims	8,10,13-15,17,18,22-25,27,39-42 1-7,9,11,12,16,19-21,26,28-31,38			
	Inve	nventive step (IS)		Yes: No:	Claims Claims	1-31,38-42		
	Industrial applicability (IA)		Yes: No:	Claims Claims	1-31,38-42			
2.	Cita	tions and	explanations (Rule	70.7):				
	see	separate	sheet					

Re Item IV Lack of unity of invention

This International Examination authority found multiple groups of inventions in this international application, as follows:

- A method of bonding/debonding two objects of an adhesive system, said system comprising an adhesive composition comprising an adhesive agent and/or primer and/or cleaner and thermoexpandable microspheres dispersed therein (claims 1,30,38,40). Furthermore, the adhesive system (claim 4), and a method of attaching a plurality of surfaces by using said adhesive system (claims 29,40).
- II An apparatus comprising an IR-emitting device comprising at least one bulb, at least one lens and at least one reflecting mirror.

The term "apparatus for attaching or detaching two or more surfaces" must be construed as meaning merely an apparatus suitable for attaching two or more surfaces. Since in addition no special technical feature in the sense of Rule 13.1 PCT is present, which could form a special technical link between the methods and the apparatus identified above, the present application is not considered as relating to a group of inventions so linked as to form a single general inventive concept in the sense of Rule 13.1 PCT.

Re Item V

Reasoned statement with regard to novelty, inventive step or industrial applicability; citations and explanations supporting such statement

- 1 Reference is made to the following documents:
 - D1: WO-A-0075254 (BAIN P S; MANFRE G); 14.12.2000
 - D2: EP-A-1126001 (NITTO DENKO CORP), 22.08.2001
- The present application does not meet the criteria of Article 33(1) PCT, because the subject-matter of independent claims 1,4,29,30,38 lacks novelty in the sense of Article 33(2) PCT.

- 2.1 The document D1 discloses (claims; page 8, lines 1,2) a method of bonding and subsequently debonding vehicle windscreens. The method comprises the steps of a) applying an adhesive composition comprising I) an adhesive agent, ii) thermoexpandable microspheres encapsulating a blowing agent, having a diameter of 10 to 120 μm and an activation temperature of 80 to 170°C, and iii) an optionally encapsulated curing agent to a vehicle windscreen, b) allowing the composition to cure, c) applying a heat source to the cured adhesive in order to cause thermoexpansion of the microspheres and thus weaken the adhesive bond, and d) removing the windscreen.
 - Hence, the subject-matter of present claims 1,4,29,30,38 and 40 lacks novelty in view of this teaching (Article 33(2) PCT).
- 2.2 The document D2 discloses (claim 7; paragraphs [49],[52],[53]) a method of attaching and subsequently debonding a semiconductor wafer. The method comprises the steps of a) applying an adhesive composition comprising an adhesive agent, a crosslinking compound and thermoexpandable microspheres (Matsumoto F-50D®) encapsulating a blowing agent and having a diameter of appr. 15 μm and an activation temperature of 130°C to a vehicle windscreen, b) allowing the composition to cure, c) applying a heat source to the cured adhesive in order to cause thermoexpansion of the microspheres and thus weaken the adhesive bond, and d) removing the wafer.
 - Hence, the subject-matter of claims 4,29,30,38 lacks novelty in view of this teaching (Article 33(2) PCT).
- 2.3 The dependent claims do not contain any features which, in combination with the features of any claim to which they refer, meet the requirements of the PCT in respect of novelty and/or inventive step.



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HARRISON GODDARD

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Claims

- 1. A method of bonding and debonding two or more surfaces or supports or layers of an adhesive system, the adhesive system comprising an adhesive composition at its bonded surface(s), the composition being placed between said surfaces or supports or layers, and the adhesive composition comprising an adhesive agent and/or a primer and/or a cleaner at its interface and dispersed therein at least two sets of thermoexpandable microspheres that are not simultaneously activatable, a first set of microspheres being associated with curing and bonding and a second set of microspheres being associated with debonding, in order to debond the system a sufficient power level of thermal radiation and/or thermal energy is provided which concentrates on the adhesive surfaces so as to expand the second set of microspheres in the adhesive and/or a primer and/or a cleaner layers and so causes weakening of adhesive surface forces at the interface of said layers in the adhesive system.
- A method according to claim 1 wherein the power level of thermal radiation and/or thermal conduction and/or thermal energy which passes through the adhesive composition causes the contents of the expanded microspheres to leach or migrate through their porous shells into the matrix of the composition.
 - 3. A method according to either claim 1 or 2 wherein the microspheres encapsulate a blowing agent which acts as a carrier for the contents of the microspheres.
- 4. An adhesive system comprising curing an adhesive composition and/or debonding the same adhesive at its bonded surface, the composition being placed between two or more surfaces of supports or layers, and the adhesive composition comprising an adhesive and/or cleaner and/or primer at its interface and dispersed therein thermo-expandable microspheres the system comprising the steps of:
- 30 (i) activating a method of curing the composition by providing a first power level of thermal radiation and/ or thermal conduction and/or thermal energy



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which passes through the adhesive composition so the contents of the expanded microspheres leach or migrate through their porous shells into the matrix of the composition and;

- (ii) de-bonding adhesive interfaces of the same surfaces of supports or layers by providing a second power level of thermal radiation and/ or thermal conduction and/or thermal energy which concentrates on the adhesive surfaces so as to expand the microspheres in the adhesive and/or cleaner and/or primer layers and so cause weakening of adhesive surface forces in the interface of the adhesive composition.
 - 5. A system according to claim 4 wherein step (i) is performed after adhesive composition deposition and step (ii) is performed days, weeks, months or years apart.
- 6. A method or system according to any preceding claim wherein the microspheres comprise a co-polymeric shell which encapsulates an expanding agent for the debonding microspheres and a curing agent or catalyst mixed with an expanding agent for step the curing microspheres.
- 7. A method or system according to claim 6 wherein the expanding agent is selected from the group comprising an expandable gas, a volatile agent, a sublimation agent, water, an agent which attracts water or an explosive agent.
 - 8. A method or system according to any of claims 2 to 7 wherein the microspheres encapsulating the curing agent have a larger cross sectional diameter than those encapsulating the expanding agent.
 - 9. A method or system according to any of claims 2 to 8 further comprising a curing activator.
- 30 10. A method or system according to claim 9 wherein the curing activator is activated by an applied thermal energy or by its own energy.

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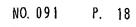
- 11. A method or system according to any preceding claim wherein the adhesive is polyurethane or polyvinylchloride or an MS polymer or an epoxy resin.
- 12. A method or system according to any preceding claim wherein the microspheres are activated in a temperature range of about 45 to 220 °C for the debonding phase.
- 13. A method or system according to any of claims 2 to 12 claim wherein the proportion of microspheres encapsulating the curing agent are activated at a different temperature from those used in the debonding phase the temperature difference being between 20 to 100 °C.
- 14. A method or system according to any preceding claim wherein the microspheres used in debonding microspheres encapsulating the expanding agent comprise about 3-5% weight in the cleaner and 5-10% weight in the primer at the adhesive interface.
- 15. A method or system according to any one of claims 2 to 14 wherein the microspheres used in curing encapsulating the curing agent or catalyst comprise about 2-3% weight of the composition.
 - 16. A method or system according to any preceding claim wherein the thermal radiation and/ or thermal conduction provided to the microspheres is provided by a means comprising a source of IR or UV electromagnetic radiation, or from a convection oven or from electrical means, a battery or a laser or from an ultrasonic source or from gas or from white light or microwaves or sonic waves.
 - 17. A method or system according to claim 16 wherein in the instance of using IR radiation it is provided as a wavelength of about 800-1400 nm to 2000-6000 nm and concentrates heating radiation on the microspheres in order to reach their activation expanding temperature in advance of the adhesive matrix degradation temperature.

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- 18. A method or system according to any preceding claim wherein the thermoexpandable microspheres are provided embedded in or coated on to a tape or mesh or film or attached to a wire or filament or fibre.
- 5 19. A method or system according to any preceding claim wherein the microspheres are coated in a black material.
 - 20. A method or system according to any of claims 1 to 17 wherein the microspheres are coated with or encapsulate a monomer and/or with nanoparticles dispersed in the porous initial microsphere shell.
 - 21. A method or system according to any preceding claim wherein the microspheres act as a vehicle or transporter or carrier or barrier or dispersing aid or aid to prevention of clustering of particles or nanoparticles or detergent or cleaning agent in a mixture comprising a binder and solvent, the microspheres either encapsulating a desired agent or being coated with it.
 - 22. A method or system according to any preceding claim wherein the microspheres are dispersed in an arrangement of micro-wires so as to form a polygonal arrangement.
 - 23. A method or system according to claim 22 wherein the micro-wires are about 100-200µ in length.
- 25 24. A method or system according to claim 23 wherein the micro-wires are about 2-20µ in diameter.
 - 25. A method or system according to any one of claims 22 to 24 wherein the composition comprises about 1-10% volume of micro-wires.

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- 26. A method or system according to any preceding claim wherein the thermoexpandable microspheres are attached to a contact surface of one or more of the components which it is desired to attach and/or separate or on an internal surface of the components or at an interface of the cleaner and/or primer of said components.
- 27. A method or system according to any preceding claim wherein the adhesive composition comprising the microspheres is provided in a continuous or discontinuous predefined or in spots in path or channel or groove or line or concentric circles provided substantially around the periphery of one or both of the contact surfaces of the items which it is desired to attach or detach.
- 28. A method or system according to any preceding claim wherein the depth and breadth or thickness and wideness of the adhesive composition may be uniform or may vary as required in areas of the surface(s) which need to be attached or detached.
- 29. A method of attaching or bonding two or more surfaces together comprising:
- (i) applying an adhesive composition according to any preceding claim to one or more of the contact surfaces of each or all items which is to be bonded together; and
- 20 (ii) supplying sufficient thermal radiation and/ or thermal conduction to the composition via contact with one or more of the contact surfaces of each or all items which is to be bonded together so as to cause a proportion of the thermoexpandable microspheres to expand and optionally to further release a curing agent into the composition during the bonding process.
 - 30. A method of detaching or debonding two or more surfaces that have been bonded together comprising, supplying sufficient thermal radiation and/ or thermal conduction to a surface having coated thereon or attached thereto the composition as defined in either claim 1 or claim 4, the thermal energy being supplied to one or more of the contact surfaces of each item which are to be detached/separated so as to cause

AMENDED SHEET

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the thermoexpandable microspheres to increase in volume and to become a pressure activator so as to debond the interfaces of the adhesion system.

- A method according to claim 30 further including any one or more of the 31. features recited in claims 2 to 29 regarding the debonding of interfaces. 5
 - An apparatus for attaching or detaching two or more surfaces that have been 32. bonded together comprising an IR emitting device comprising at least one bulb, at least one lens and at least one reflecting mirror mutually arranged so that heat is directed or focused only at an adhesive interface or a path where the thermoexpandable microspheres are purposely present.
 - An apparatus according to claim 32 capable of emitting IR radiation in the range of about 800-1400 nm to 2000-6000 nm.
- An apparatus according to either claim 31 or 32 that is automated and operably linked to a computer programme providing information to device sensors of an adhesive bonding path.
- An apparatus according to any one of claims 32 to 34 mounted on a mobile 20 35. unit so that it is free to follow a predefined adhesive bonding path.
- An apparatus according to any one of claims 32 to 35 capable of 36. concentrating an IR beam at certain partial points of the surface which it is desired to bond or de-bond in different steps at command. 25
 - An apparatus according to any one of claims 32 to 36 that is pre-programmed 37. to follow a specific bonding path in direction, width and breadth.
- A method of de-bonding an adhesive composition, the composition being 30 present at an interface and being placed between two or more surfaces of vehicle

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glazing or vehicle panel(s) or part(s) the composition comprising an adhesive or cleaner and/or primer and thermoexpandable microspheres dispersed therein the microspheres having a diameter of between 10-50 µm and an activation temperature range of between 110-210 Co and encapsulating at least one blowing agent the debonding being effected by exposing the microspheres power level of thermal radiation and/or thermal energy that results in a temperature received by the microspheres in the range of 110-210 C°.

- A method according to claim 38 further comprising curing the adhesive 39. composition prior to be bonding the curing comprising providing microspheres of 30-10 50 μm in diameter with an activation temperature range of between 50-100 C° the microspheres encapsulating a curing agent and/or catalyst and/or activator and effecting curing by exposing the microspheres power level of thermal radiation and/or thermal energy that results in a temperature received by the microspheres in the range of 50-100 C°. 15
 - A method of curing an adhesive and de-bonding the same adhesive from 40. automotive glazing or panels or parts comprising applying a composition comprising an adhesive and thermoexpandable microspheres dispersed therein, a first set of microspheres having a diameter of between 30-50 µm and an activation temperature range of between 50-100 C° and a second set of microspheres having a diameter of between 10-50 μ m and an activation temperature range of between 110-210 C° the second set of microspheres being present at an interface of the adhesive or cleaner and/or primer, the composition being placed between two or more surfaces of the glazing or panel or part(s) and:
 - activating curing of the composition by exposing it to a first power (i) level of thermal radiation and/or thermal energy that results in a temperature received by the microspheres in the range of 50-100 C°; and
- de-bonding the adhesive system at its interfaces by exposing it to a (ii) first power level of thermal radiation and/or thermal energy that results in a 30 temperature received by the microspheres in the range of 110-210 C°.

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41. A method according to any one of claims 38 to 40 further comprising any one or more of the features recited in claims 2 to 28.

42. A method according to any one of claims 38 to 41 for the removal of vehicle glazing or panels or parts in an end of vehicle life process.

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P101655wo.amended claims

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